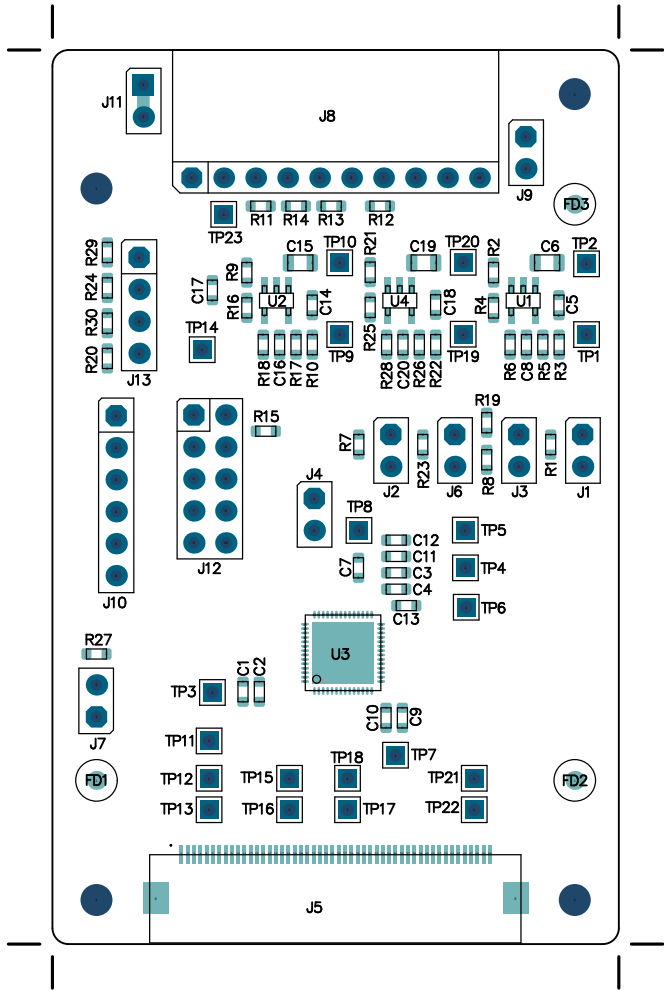




ASSEMBLY NOTES:

1. ALL COMPONENTS SHALL BE RoHS COMPLIANT.
2. ALL UNUSED THROUGH HOLE COMPONENT LOCATIONS SHALL BE FREE OF SOLDER.
3. ALL TEST POINT THROUGH HOLES (DENOTED TPxx) SHALL BE FREE OF SOLDER.
4. ALL COMPONENTS SHALL BE MOUNTED FLUSH TO THE BOARD, EXCEPT AS NOTED.
5. FINISHED BOARD SHALL BE FREE OF ALL RESIDUES.
6. ALL LEADS SHALL BE TRIMMED TO A MAXIMUM HEIGHT OF 2mm.
7. PLACE LABELS ON THE LOCATION INDICATED.



MICROCHIP
Microchip Technology Inc.
2355 W. Chandler Blvd.
Chandler, AZ 85224

TITLE:
mXT336UD EVK Control Board

PCB DESIGNER:
Patrick Cassidy

ENGINEER:
Patrick Cassidy

PCB FILE NAME:
11560.PcbDoc

GERBER FILE:
Top Assembly Drawing

BOARD NUMBER:
04-11560

LAYER NAME:
Top Assembly (M11)

DOCUMENT NUMBER:
02-00454

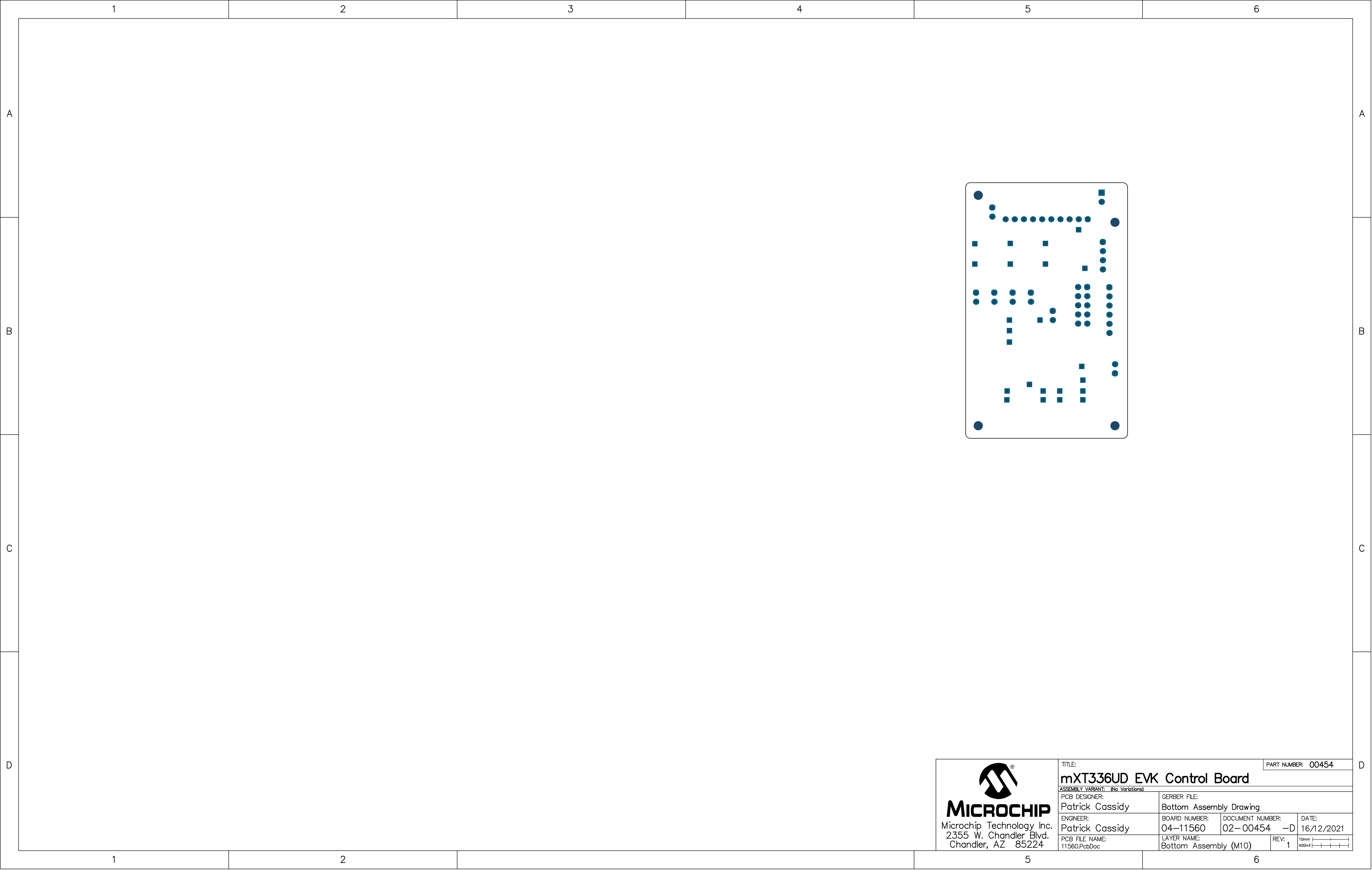
DATE:
16/12/2021

REV: 1

PART NUMBER: 00454

10mm
400mil

REV	ECO	Comments	Date
1	N/A	First Issue	16th Dec 2021



MICROCHIP
Microchip Technology Inc.
2355 W. Chandler Blvd.
Chandler, AZ 85224

TITLE:		PART NUMBER: 00454	
mXT336UD EVK Control Board			
ASSEMBLY VARIANT: (No Variations)			
PCB DESIGNER: Patrick Cassidy		GERBER FILE: Bottom Assembly Drawing	
ENGINEER: Patrick Cassidy		BOARD NUMBER: 04-11560	DOCUMENT NUMBER: 02-00454 -D DATE: 16/12/2021
PCB FILE NAME: 11560.PcbDoc		LAYER NAME: Bottom Assembly (M10)	REV: 1 10mm 400mil

